



Raise3D Pro3 **HS** Series

Beyond Speed: 3D Printing Large Composite Parts Made Simple

The Raise3D Pro3 HS Series is a powerful professional-grade machine that builds upon the various performance improvements introduced on Raise3D's flagship Pro3 Series. It improves on printing speed, production efficiency and reliability. With Hyper FFF® technology, it offers high-speed printing for composite materials. The new auto filament switching function and supports 2.5kg filament spools, with the goal of bestowing general manufacturers and print farmers with the ability to produce small batches efficiently and reliably, whether they're end-use parts or tooling fixtures.



High-Speed Printing with High-Performance Composite Materials



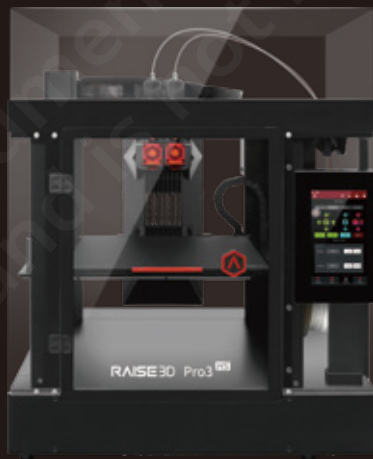
Enhanced Speed and Accuracy for Industrial Applications



Longer-Lasting Reliability and Durability



Maximize Production Efficiency with Minimal Manual Intervention



- Built-in Hyper FFF® Technology
- New Printing Build Plate
- 2.5kg Large Roll Storage Boxes*
- Hyper Core Filament and New Hot-end in the Box

- Motion Control Upgrade with a Closed-Loop Motor
- New RFID Filament Sensor
- Auto Filament Switching

*2.5kg filament box needs to be purchased separately.

Printer	Raise3D Pro3 HS		Raise3D Pro3 Plus HS	
Build Volume (W × D × H)	Single Extruder Print	Dual Extruder Print	Single Extruder Print	Dual Extruder Print
	300 × 300 × 300 mm (11.8 × 11.8 × 11.8 inch)	255 × 300 × 300 mm (10 × 11.8 × 11.8 inch)	300 × 300 × 605 mm (11.8 × 11.8 × 23.8 inch)	255 × 300 × 605 mm (10 × 11.8 × 23.8 inch)
Machine Size (W × D × H)	620 × 626 × 760 mm (24.4 × 24.6 × 29.9 inch)		620 × 626 × 1105 mm (24.4 × 24.6 × 43.5 inch)	
Weight	Net Weight	Gross Weight (Carton with Pallet)	Net Weight	Gross Weight (Carton with Pallet)
	54 kg (119 lbs)	75.7 kg (166.9 lbs)	64 kg (141 lbs)	88.7 kg (195.5 lbs)
General	Print Technology Print Head System Filament Diameter XYZ Step Size Standard Printing Speed Build Plate Build Plate Leveling Heated Bed Material Heated Bed Max Temperature Nozzle Diameter Max Nozzle Temperature Layer Height Automatic Filament Switching RFID Sensor Filament Run-Out Sensor Filter Eve Smart Assistant Connectivity Noise Emission Operating Ambient Storage Temperature Fused Filament Fabrication (FFF) Dual-head with Electronic Lifting System 1.75 mm 0.78125, 0.78125, 0.078125 micron 300 mm/s Flexible Steel Plate with BuildTak Mesh-leveling with Flatness Detection Silicone 120°C 0.4 mm (Default), 0.2/ 0.6/ 0.8/ 1.0 mm (Available) 320°C The Pro3 HS Series is compatible with 0.2, 0.4, 0.6, 0.8 and 1.0 mm nozzles, and the layer height can vary between 0.05-0.6 mm. To achieve stable print results, when using 0.4 mm nozzles, we recommend using a layer height between 0.1-0.3 mm. Available (Coming Soon) Available (Coming Soon) Available HEPA Filter with Activated Charcoal Available Wi-Fi, LAN, USB port, Live Camera < 55 dB (A) When Building 15-30°C, 10-90% RH, non-condensing -25°C to +55°C, 10-90% RH, non-condensing			
Electrical	Power Supply Input Power Supply Output 100-240 V AC, 50/ 60 Hz 230 V @ 3.3 A 24 V DC, 600 W			
Material	Material Type Third Party Material Hyper Core: PPA CF/ PPA GF/ ABS CF Hyper Speed: PLA/ ABS Industrial: PPA CF/ PPA GF/ PET CF/ PET GF/ PETG ESD/ PET Support/ PPA Support Premium: PLA/ ABS/ ASA/ PETG/ PC/ TPU-95A/ PVA+ Supported by Raise3D OFP (Open Filament Program)*			
Software	Slicing Software Supported File Types Supported OS Machine Code Type ideaMaker STL/ OBJ/ 3MF/ OLTP/ STEP/ STP/ IGES/ IGS Windows/ macOS/ Linux GCODE			
Printer Controller	User Interface Network Power Loss Recovery Screen Resolution Motion Controller Logic Controller Memory Onboard Flash OS Ports 7-inch Touch Screen Wi-Fi, Ethernet Available 1024 × 600 Atmel ARM Cortex-M4 120 MHz FPU NXP ARM Cortex-A9 Quad 1 GHz 1 GB 16 GB Embedded Linux USB 2.0 × 2, Ethernet × 1			

*For detailed information and slicing profiles of the materials supported by Raise3D OFP, please visit <https://www.ideamaker.io/>.